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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	14KB (8K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c66-20i-so

4.2.2.5 PIR1 REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the individual flag bits for the peripheral interrupts.

Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an

interrupt.

FIGURE 4-16: PIR1 REGISTER FOR PIC16C62/62A/R62 (ADDRESS 0Ch)

R/	/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
-	_	_	_	_	SSPIF	CCP1IF	TMR2IF	TMR1IF	R = Readable bit
bit7								bit0	U = Unimplemented bit, read as '0'
		_							- n = Value at POR reset

- bit 7-6: Reserved: Always maintain these bits clear.
- bit 5-4: Unimplemented: Read as '0'
- bit 3: SSPIF: Synchronous Serial Port Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 2: CCP1IF: CCP1 Interrupt Flag bit

Capture Mode

- 1 = A TMR1 register capture occurred (must be cleared in software)
- 0 = No TMR1 register capture occurred

Compare Mode

- 1 = A TMR1 register compare match occurred (must be cleared in software)
- 0 = No TMR1 register compare match occurred

PWM Mode

Unused in this mode

- bit 1: TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
 - 1 = TMR2 to PR2 match occurred (must be cleared in software)
 - 0 = No TMR2 to PR2 match occurred
- bit 0: TMR1IF: TMR1 Overflow Interrupt Flag bit
 - 1 = TMR1 register overflow occurred (must be cleared in software)
 - 0 = No TMR1 register overflow occurred

Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

4.2.2.8 PCON REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Power Control register (PCON) contains a flag bit to allow differentiation between a Power-on Reset to an external MCLR reset or WDT reset. Those devices with brown-out detection circuitry contain an additional bit to differentiate a Brown-out Reset condition from a Power-on Reset condition

Note: BOR is unknown on Power-on Reset. It must then be set by the user and checked on subsequent resets to see if BOR is clear, indicating a brown-out has occurred. The BOR status bit is a "don't care" and is not necessarily predictable if the brown-out circuit is disabled (by clearing the BODEN

bit in the Configuration word).

FIGURE 4-22: PCON REGISTER FOR PIC16C62/64/65 (ADDRESS 8Eh)

R/W-0 R/W-q U-0 U-0 U-0 U-0 U-0 U-0 POR = Readable bit W = Writable bit bit7 hit0 = Unimplemented bit, read as '0' n = Value at POR reset = value depends on conditions Unimplemented: Read as '0' hit 7-2. bit 1: POR: Power-on Reset Status bit 1 = No Power-on Reset occurred 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs) bit 0: Reserved This bit should be set upon a Power-on Reset by user software and maintained as set. Use of this bit as a general purpose read/write bit is not recommended, since this may affect upward compatibility with future products.

FIGURE 4-23: PCON REGISTER FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67 (ADDRESS 8Eh)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-q	
_	_	_	_	-	_	POR	BOR	R = Readable bit
bit7							bit0	W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset q = value depends on conditions
bit 7-2:	Unimplem	ented: Rea	ıd as '0'					
bit 1:	POR : Power 1 = No Power 0 = A Power	ver-on Rese	et occurred	must be se	in software	after a Pow	er-on Reset	occurs)
bit 0:	BOR: Brow 1 = No Bro 0 = A Brow	wn-out Res	et occurred	i	et in software	after a Bro	wn-out Rese	et occurs)

Example 4-1 shows the calling of a subroutine in page 1 of the program memory. This example assumes that the PCLATH is saved and restored by the interrupt service routine (if interrupts are used).

EXAMPLE 4-1: CALL OF A SUBROUTINE IN PAGE 1 FROM PAGE 0

```
ORG 0x500
BSF PCLATH,3 ;Select page 1 (800h-FFFh)
BCF PCLATH,4 ;Only on >4K devices

CALL SUB1_P1 ;Call subroutine in
;;page 1 (800h-FFFh)
;
ORG 0x900
SUB1_P1: ;called subroutine
;;page 1 (800h-FFFh)
;
RETURN ;return to Call subroutine
;in page 0 (000h-7FFh)
```

4.5 Indirect Addressing, INDF and FSR Registers

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

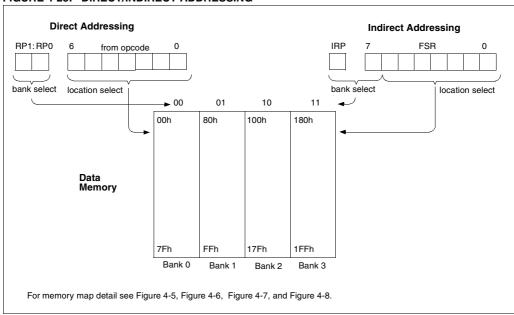
Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses the register pointed to by the File Select Register, FSR. Reading the INDF register itself indirectly (FSR = '0') will produce 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-25.

A simple program to clear RAM location 20h-2Fh using indirect addressing is shown in Example 4-2.

EXAMPLE 4-2: INDIRECT ADDRESSING

```
movlw 0x20
                        ;initialize pointer
         movwf FSR
                        ; to RAM
NEXT
         clrf
                INDF
                        ;clear INDF register
                FSR,F
          incf
                        ;inc pointer
         btfss FSR,4
                        ;all done?
                        ;NO, clear next
         goto NEXT
CONTINUE
                        ;YES, continue
```

FIGURE 4-25: DIRECT/INDIRECT ADDRESSING



NOTES:

5.0 I/O PORTS

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Some pins for these I/O ports are multiplexed with an alternate function(s) for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

All devices have a 6-bit wide PORTA, except for the PIC16C61 which has a 5-bit wide PORTA.

Pin RA4/T0CKI is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as output or input.

Setting a bit in the TRISA register puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISA register puts the contents of the output latch on the selected pin.

Reading PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified, and then written to the port data latch

Pin RA4 is multiplexed with Timer0 module clock input to become the RA4/T0CKI pin.

EXAMPLE 5-1: INITIALIZING PORTA

```
BCF
       STATUS, RP0
BCF
       STATUS, RP1 ; PIC16C66/67 only
                    ; Initialize PORTA by
CLRE
       PORTA
                    : clearing output
                    ; data latches
BSF
       STATUS, RPO ; Select Bank 1
                    ; Value used to
MOVLW
       0xCF
                    : initialize data
                    : direction
MOVWF TRISA
                    ; Set RA<3:0> as inputs
                    ; RA<5:4> as outputs
                    ; TRISA<7:6> are always
                    ; read as '0'.
```

FIGURE 5-1: BLOCK DIAGRAM OF THE RA3:RA0 PINS AND THE RA5 PIN

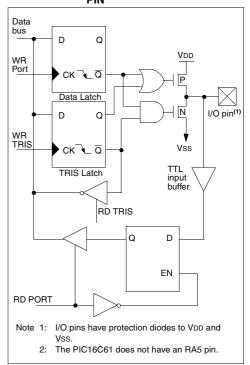
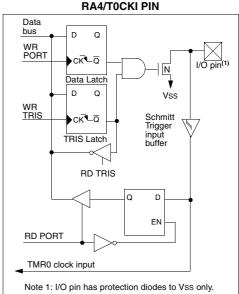


FIGURE 5-2: BLOCK DIAGRAM OF THE



7.3 Prescaler

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

An 8-bit counter is available as a prescaler for the Timer0 module or as a postscaler for the Watchdog Timer (WDT), respectively (Figure 7-6). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer, and vice-versa.

The PSA and PS2:PS0 bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g. CLRF TMR0, MOVWF TMR0, BSF TMR0,bitx) will clear the prescaler count. When assigned to the Watchdog Timer, a CLRWDT instruction will clear the Watchdog Timer and the prescaler count. The prescaler is not readable or writable.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count, but will not change the prescaler assignment.

FIGURE 7-6: BLOCK DIAGRAM OF THE TIMERO/WDT PRESCALER

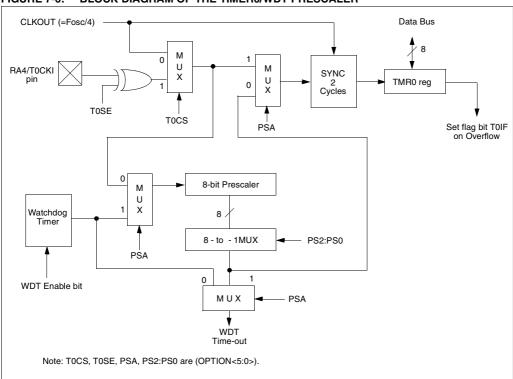


TABLE 10-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000
0Dh ⁽⁴⁾	PIR2	_	_	CCP2IF	0	0					
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000
8Dh ⁽⁴⁾	PIE2	_	_	-	_	_	_	-	CCP2IE	0	0
87h	TRISC	PORTC I	Data Direction	on register			ı			1111 1111	1111 1111
11h	TMR2	Timer2 m	odule's reg	ister						0000	0000
92h	PR2	Timer2 m	odule's Per	iod register						1111 1111	1111 1111
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
15h	CCPR1L	Capture/0	Compare/P\	WM1 (LSB)		ı	l			xxxx	uuuu uuuu
16h	CCPR1H	Capture/0	Compare/P\	WM1 (MSB)					xxxx	uuuu uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
1Bh ⁽⁴⁾	CCPR2L	Capture/0	Compare/P\	WM2 (LSB)	I	I	I			xxxx	uuuu uuuu
1Ch ⁽⁴⁾	CCPR2H	Capture/0	Compare/P\	WM2 (MSB)					xxxx	uuuu uuuu
1Dh ⁽⁴⁾	CCP2CON	_	_	CCP2X	CCP2Y	ССР2М3	CCP2M2	CCP2M1	ССР2М0	00 0000	00 0000

 $\begin{tabular}{ll} Legend: & x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used in this mode. \\ \end{tabular}$

Note 1: These bits are associated with the USART module, which is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

^{2:} Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

^{3:} The PIR1<6> and PIE1<6> bits are reserved, always maintain these bits clear.

^{4:} These registers are associated with the CCP2 module, which is only implemented on the PIC16C63/R63/65/65A/R65/66/67.

TABLE 12-5: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD RATE (K)	FOSC = 2	% ERROR	SPBRG value (decimal)	16 MHz KBAUD	% ERROR	SPBRG value (decimal)	10 MHz KBAUD	% ERROR	SPBRG value (decimal)	7.16 MH KBAUD	z % ERROR	SPBRG value (decimal)
9.6	9.615	+0.16	129	9.615	+0.16	103	9.615	+0.16	64	9.520	-0.83	46
19.2	19.230	+0.16	64	19.230	+0.16	51	18.939	-1.36	32	19.454	+1.32	22
38.4	37.878	-1.36	32	38.461	+0.16	25	39.062	+1.7	15	37.286	-2.90	11
57.6	56.818	-1.36	21	58.823	+2.12	16	56.818	-1.36	10	55.930	-2.90	7
115.2	113.636	-1.36	10	111.111	-3.55	8	125	+8.51	4	111.860	-2.90	3
250	250	0	4	250	0	3	NA	-	-	NA	-	-
625	625	0	1	NA	-	-	625	0	0	NA	-	-
1250	1250	0	0	NA	-	-	NA	-	-	NA	-	-

BAUD	Fosc = 5	5.068 MHz	SPBRG	4 MHz		SPBRG	3.579 MI	Ηz	SPBRG	1 MHz		SPBRG	32.768 I	kHz	SPBRG
RATE (K)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)
9.6	9.6	0	32	NA	-	-	9.727	+1.32	22	8.928	-6.99	6	NA	-	-
19.2	18.645	-2.94	16	1.202	+0.17	207	18.643	-2.90	11	20.833	+8.51	2	NA	-	-
38.4	39.6	+3.12	7	2.403	+0.13	103	37.286	-2.90	5	31.25	-18.61	1	NA	-	-
57.6	52.8	-8.33	5	9.615	+0.16	25	55.930	-2.90	3	62.5	+8.51	0	NA	-	-
115.2	105.6	-8.33	2	19.231	+0.16	12	111.860	-2.90	1	NA	-	-	NA	-	-
250	NA	-	-	NA	-	-	223.721	-10.51	0	NA	-	-	NA	-	-
625	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1250	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-

Note: For the PIC16C63/R63/656A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

RLF	Rotate Left f the	rough Ca	rry	RRF	Rotate F	Right f th	rough C	arry
Syntax:	[label] RLF	f,d		Syntax:	[label]	RRF f,	d	
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$			Operands:	$0 \le f \le 12$ $d \in [0,1]$			
Operation:	See description	below		Operation:	See des	cription b	elow	
Status Affected:	С			Status Affected:	С			
Encoding:	00 1101	dfff	ffff	Encoding:	0.0	1100	dfff	ffff
Description:	The contents of re one bit to the left ti Flag. If 'd' is 0 the W register. If 'd' is back in register 'f'.	nrough the result is pla	Carry ced in the	Description:	one bit to Flag. If 'd'	the right t is 0 the re r. If 'd' is 1 gister 'f'.	ister 'f' are hrough the esult is pla- the result Register f	e Carry ced in the
Words:	1			Words:	1			
Cycles:	1			Cycles:	1			
Q Cycle Activity:	Q1 Q2	Q3	Q4	Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode Read register 'f'	Process data	Write to destination		Decode	Read register 'f'	Process data	Write to destination
Example	RLF R	EG1,0		Example	RRF		REG1,0	
	Before Instruction	n			Before Ir	struction	1	
	REG1 C	= 111 = 0	0 0110			REG1		0 0110
	After Instruction	= 0			After Ins	C	= 0	
	REG1	= 111	0 0110		7 (113)	REG1	= 111	0 0110
	W	= 110	0 1100			W	= 011	1 0011
	С	= 1				С	= 0	

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended,

-40°C \leq TA \leq +85°C for industrial and 0°C \leq TA \leq +70°C for commercial

0°C ≤ IA ≤ +/0°C for commercial

Operating voltage VDD range as described in DC spec Section 15.1 and Section 15.2.

	Oction 10.2.												
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions						
	Output High Voltage												
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C						
D090A			VDD-0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5V, -40°C to +125°C						
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C						
D092A			VDD-0.7	-	-	V	IOH = -1.0 mA, VDD = 4.5V, -40°C to +125°C						
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin						
	Capacitive Loading Specs on Output Pins												
D100	OSC2 pin	Cosc2			15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.						
D101	All I/O pins and OSC2 (in RC mode)	Cio			50	pF							

* The parameters are characterized but not tested.

DC CHARACTERISTICS

- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

FIGURE 17-5: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

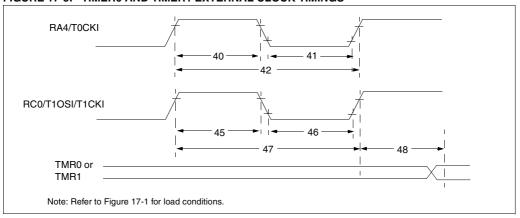


TABLE 17-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	TtOL	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	_	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100	-	_	ns	
	Ft1	Timer1 oscillator inp			DC	-	200	kHz	
		(oscillator enabled b							
48 * T		1 Delay from external			2Tosc	_	7Tosc	_	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 18-6: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

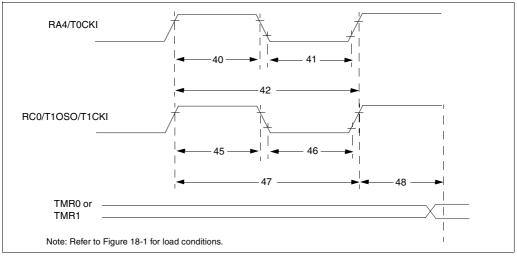


TABLE 18-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler With Prescaler	Tcy + 40	_	_	ns	
					Greater of: 20 or <u>Tcy + 40</u> N	_	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100	_	_	ns	
	Ft1	Timer1 oscillator inp			DC	_	200	kHz	
		(oscillator enabled b		· · · · · · · · · · · · · · · · · · ·					
48	TCKEZtmr	Delay from external	clock edge to tir	ner increment	2Tosc	-	7Tosc	_	

^{*} These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-7: PARALLEL SLAVE PORT TIMING

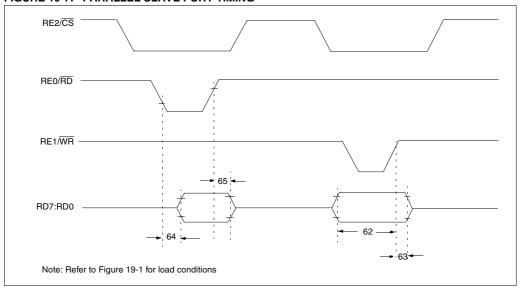


TABLE 19-7: PARALLEL SLAVE PORT REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before WR↑ or CS↑ (setup	ta in valid before WR↑ or CS↑ (setup time)		_	_	ns	
63*	TwrH2dtl	WR↑ or CS↑ to data–in invalid (hold	PIC16 C 65	20	_	_	ns	
		time)	PIC16 LC 65	35	_	_	ns	
64	TrdL2dtV	RD↓ and CS↓ to data–out valid	•	_	_	80	ns	
65	TrdH2dtl	RD↑ or CS↑ to data–out invalid	↑ or CS↑ to data-out invalid		_	30	ns	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-6: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

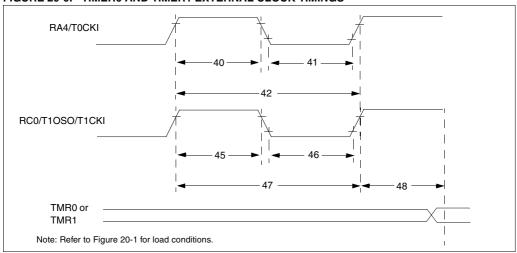


TABLE 20-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	-	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F	rescaler = 1	0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	rescaler = 1	0.5TCY + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	-	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16LC6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100			ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b			DC	_	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tir	ner increment	2Tosc	_	7Tosc	_	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 21-10: I²C BUS START/STOP BITS TIMING

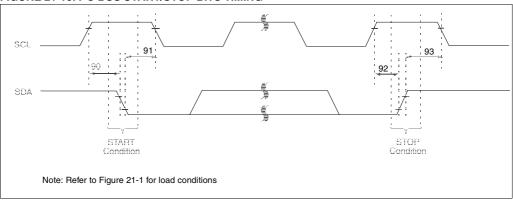


TABLE 21-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions	
90*	TSU:STA	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated START	
		Setup time	400 kHz mode	600		_	110	condition	
91*	THD:STA	START condition	100 kHz mode	4000	_	_	ns	After this period the first clock	
		Hold time	400 kHz mode	600	_	_	113	pulse is generated	
92*	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns		
		Setup time	400 kHz mode	600	_	_	113		
93	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns		
Ì		Hold time	400 kHz mode	600	_	_	113		

These parameters are characterized but not tested.

FIGURE 22-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

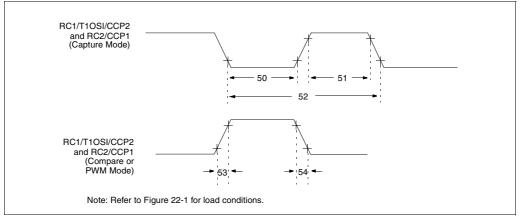


TABLE 22-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2 input low time	No Prescaler		0.5Tcy + 20	_	_	ns	
			With Prescaler	PIC16 C 66/67	10	_	_	ns	
				PIC16 LC 66/67	20	_	_	ns	
51*	TccH	COLL AND COLZ	No Prescaler		0.5Tcy + 20	_	_	ns	
			With Prescaler	PIC16 C 66/67	10	_	_	ns	
				PIC16 LC 66/67	20	_	_	ns	
52*	TccP	CCP1 and CCP2 input period		3Tcy + 40 N	_	_	ns	N = prescale value (1,4, or 16)	
53*	TccR	CCP1 and CCP2 output rise time PIC16 C 66/67 PIC16 LC 66/67		PIC16 C 66/67	_	10	25	ns	
				PIC16 LC 66/67	_	25	45	ns	
54*	TccF	CCP1 and CCP2 output fall time		PIC16 C 66/67	_	10	25	ns	
				PIC16 LC 66/67	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 22-14: I²C BUS DATA TIMING

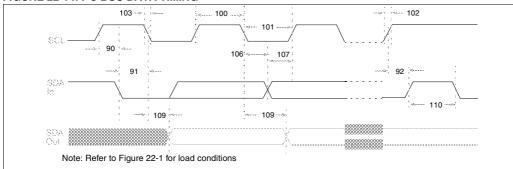


TABLE 22-10: I²C BUS DATA REQUIREMENTS

Parameter	Sym	Characteristic		Min	Max	Units	Conditions	
No.								
100*	THIGH	Clock high time	100 kHz mode	4.0	_	μS	Device must operate at a mini- mum of 1.5 MHz	
			400 kHz mode	0.6	_	μS	Device must operate at a mini- mum of 10 MHz	
			SSP Module	1.5TcY	_			
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μS	Device must operate at a mini- mum of 1.5 MHz	
İ			400 kHz mode	1.3	_	μs	Device must operate at a mini- mum of 10 MHz	
			SSP Module	1.5Tcy	_			
102*	TR	SDA and SCL rise	100 kHz mode	_	1000	ns		
l		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF	
103*	TF	SDA and SCL fall time	100 kHz mode	_	300	ns		
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF	
90*	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated	
		setup time	400 kHz mode	0.6	_	μS	START condition	
91*	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock	
		time	400 kHz mode	0.6	_	μS	pulse is generated	
106*	THD:DAT	Data input hold time	100 kHz mode	0	_	ns		
			400 kHz mode	0	0.9	μS		
107*	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2	
			400 kHz mode	100	_	ns		
92*	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μS		
		time	400 kHz mode	0.6	_	μS		
109*	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1	
		clock	400 kHz mode	_	_	ns		
110*	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free	
ı			400 kHz mode	1.3	_	μs	before a new transmission can start	
	Cb	Bus capacitive loading		_	400	pF		

These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

FIGURE 23-29: TYPICAL IDD vs. FREQUENCY (HS MODE, 25°C)

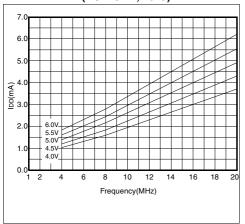
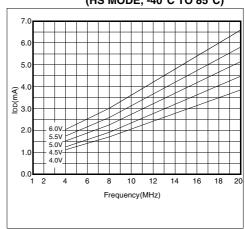


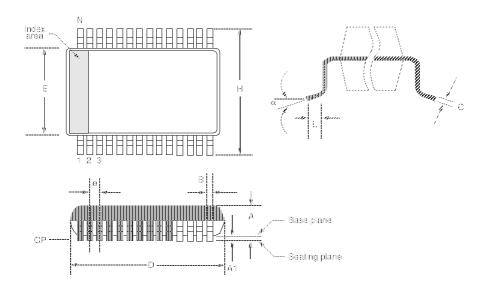
FIGURE 23-30: MAXIMUM IDD vs. FREQUENCY (HS MODE, -40°C TO 85°C)



Mote:

24.10 28-Lead Plastic Surface Mount (SSOP - 209 mil Body 5.30 mm) (SS)

For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Package Group: Plastic SSOP								
		Millimeters		Inches					
Symbol	Min	Max	Notes	Min	Max	Notes			
α	0°	8°		0°	8°				
Α	1.730	1.990		0.068	0.078				
A1	0.050	0.210		0.002	0.008				
В	0.250	0.380		0.010	0.015				
С	0.130	0.220		0.005	0.009				
D	10.070	10.330		0.396	0.407				
E	5.200	5.380		0.205	0.212				
е	0.650	0.650	Reference	0.026	0.026	Reference			
Н	7.650	7.900		0.301	0.311				
L	0.550	0.950		0.022	0.037				
N	28	28		28	28				
CP	-	0.102		-	0.004				

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